High Frequency 50 GHz Thin Film Chip Resistor

FEATURES
- Operating frequency 50 GHz
- Thin film microwave resistors
- Flip chip, wraparound or one face termination
- Small size, down to 20 mils by 16 mils
- Edged trimmed block resistors
- Pure alumina substrate (99.5 %)
- Ohmic range: 10R to 500R
- Design kits available
- Small internal reactance (LC down to 1 x 10^-24)
- Tolerance 1 %, 2 %, 5 %
- TCR: 100 ppm/°C in (-55 °C, +155 °C) temperature range
- TCR: 50 ppm/°C available upon request for 10 Ω to 150 Ω ohmic range
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

ADDITIONAL RESOURCES

Those miniaturized components are designed in such a way that their internal reactance is very small. When correctly mounted and utilized, they function as almost pure resistors on a very large range of frequency, up to 50 GHz.

STANDARD ELECTRICAL SPECIFICATIONS

<table>
<thead>
<tr>
<th>MODEL</th>
<th>SIZE</th>
<th>RESISTANCE RANGE Ω</th>
<th>RATED POWER Pn W</th>
<th>LIMITING ELEMENT VOLTAGE V</th>
<th>TOLERANCE ± %</th>
<th>TEMPERATURE COEFFICIENT ± ppm/°C</th>
</tr>
</thead>
<tbody>
<tr>
<td>CH02016</td>
<td>02016</td>
<td>10 to 500</td>
<td>0.030</td>
<td>30</td>
<td>2, 5</td>
<td>100 (50 upon request)</td>
</tr>
<tr>
<td>CH0402</td>
<td>0402</td>
<td>10 to 500</td>
<td>0.050</td>
<td>37</td>
<td>1, 2, 5</td>
<td>100 (50 upon request)</td>
</tr>
<tr>
<td>CH0603</td>
<td>0603</td>
<td>10 to 500</td>
<td>0.125</td>
<td>50</td>
<td>1, 2, 5</td>
<td>100 (50 upon request)</td>
</tr>
</tbody>
</table>

DIMENSIONS in millimeters (inches)

CASE SIZE

<table>
<thead>
<tr>
<th>MODEL / TERMINATION</th>
<th>A</th>
<th>B</th>
<th>C</th>
<th>D when applicable</th>
<th>E when applicable</th>
<th>F</th>
<th>G</th>
</tr>
</thead>
<tbody>
<tr>
<td>CH02016 F / CH02016 P</td>
<td>± 0.10 (± 0.004)</td>
<td>± 0.10 (± 0.004)</td>
<td>± 0.127 (± 0.005)</td>
<td></td>
<td></td>
<td>± 0.050 (± 0.002)</td>
<td>± 0.050 (± 0.002)</td>
</tr>
<tr>
<td>CH0402 F / CH0402 N / CH0402 G</td>
<td>0.480 (0.020)</td>
<td>0.390 (0.016)</td>
<td>0.420 (0.016)</td>
<td>(1) 0.110 (0.004)</td>
<td>0.150 (0.006)</td>
<td>0.260 (0.010)</td>
<td>0.300 (0.012)</td>
</tr>
<tr>
<td>CH0402 P</td>
<td>1.000 (0.040)</td>
<td>0.600 (0.023)</td>
<td>0.500 (0.020)</td>
<td>0.150 (0.006)</td>
<td>0.350 (0.014)</td>
<td>n/a</td>
<td>n/a</td>
</tr>
<tr>
<td>CH0603 F / CH0603 N / CH0603 G</td>
<td>1.200 (0.047)</td>
<td>0.600 (0.023)</td>
<td>0.500 (0.020)</td>
<td>0.110 (0.004)</td>
<td>0.150 (0.006)</td>
<td>0.320 (0.013)</td>
<td>0.880 (0.035)</td>
</tr>
<tr>
<td>CH0603 P</td>
<td>1.520 (0.060)</td>
<td>0.750 (0.030)</td>
<td>0.500 (0.020)</td>
<td>0.250 (0.010)</td>
<td>0.510 (0.020)</td>
<td>n/a</td>
<td>n/a</td>
</tr>
<tr>
<td>CH0603 P</td>
<td>1.720 (0.068)</td>
<td>0.750 (0.030)</td>
<td>0.500 (0.020)</td>
<td>0.235 (0.009)</td>
<td>0.275 (0.011)</td>
<td>0.660 (0.026)</td>
<td>1.355 (0.053)</td>
</tr>
</tbody>
</table>

Note
(1) ± 0.070 (± 0.003)

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For technical questions, contact: sfrthinfilm@vishay.com
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### TOLERANCE VS. OHMIC VALUES

<table>
<thead>
<tr>
<th>Ohmic range</th>
<th>10 Ω ≤ R &lt; 50 Ω</th>
<th>50 Ω ≤ R ≤ 500 Ω</th>
</tr>
</thead>
<tbody>
<tr>
<td>Tolerance CH02016</td>
<td>5 %</td>
<td>2 %, 5 %</td>
</tr>
<tr>
<td>Tolerance CH0402 and CH0603</td>
<td>2 %, 5 %</td>
<td>1 %, 2 %, 5 %</td>
</tr>
</tbody>
</table>

### LAND PATTERN FOR F 'FLIP CHIP' TERMINATIONS in millimeters (inches)

<table>
<thead>
<tr>
<th>CHIP SIZE</th>
<th>Z&lt;sub&gt;max.&lt;/sub&gt; (inches)</th>
<th>X&lt;sub&gt;max.&lt;/sub&gt; (inches)</th>
<th>G&lt;sub&gt;min.&lt;/sub&gt; (inches)</th>
</tr>
</thead>
<tbody>
<tr>
<td>02016</td>
<td>0.53 (0.021)</td>
<td>0.44 (0.017)</td>
<td>0.15 (0.006)</td>
</tr>
<tr>
<td>0402</td>
<td>1.40 (0.055)</td>
<td>0.65 (0.026)</td>
<td>0.40 (0.016)</td>
</tr>
<tr>
<td>0603</td>
<td>1.71 (0.067)</td>
<td>0.90 (0.035)</td>
<td>0.76 (0.030)</td>
</tr>
</tbody>
</table>

**Note**
- Suggested land pattern: According to IPC-7351

### LAND PATTERN FOR N AND G WRAPAROUND TERMINATIONS in millimeters (inches)

<table>
<thead>
<tr>
<th>CHIP SIZE</th>
<th>Z&lt;sub&gt;max.&lt;/sub&gt; (inches)</th>
<th>G&lt;sub&gt;min.&lt;/sub&gt; (inches)</th>
<th>X&lt;sub&gt;max.&lt;/sub&gt; (inches)</th>
</tr>
</thead>
<tbody>
<tr>
<td>0402</td>
<td>1.55 (0.061)</td>
<td>0.15 (0.006)</td>
<td>0.73 (0.029)</td>
</tr>
<tr>
<td>0603</td>
<td>2.37 (0.093)</td>
<td>0.35 (0.014)</td>
<td>0.98 (0.039)</td>
</tr>
</tbody>
</table>

Dimension and tolerance of land pattern shall be defined by PCB designer; PCB can be designed according to IPC-7351A “Generic Requirements for Surface Mount Design and Land Pattern Standard”
PREFERRED MODELS AND VALUES

Vishay Sfernice highly recommend to use the smallest sizes and flip chip version to get the best performances.

Recommended Values:

10R/18R/25R/50R/75R/100R/150R/200R/250R/330R/500R

Those values are available with a MOQ of 100 pieces.

Recommended termination:

F

Recommended tolerance:

2 %

DESIGN KITS

Design kits are available Ex Stock in CH02016 and CH0402 sizes. There are 20 pieces per recommended value. F termination. 5 % tolerance.

Those kits are packaged in pieces of tape and delivered in ESD bags.

PACKAGING

Standard packaging is plastic tape and reel for all sizes. Paper tape and reel is available for sizes 0402 and 0603. Waffle pack is available for all sizes.

Depending on the type of terminations, parts will be packed differently:

One face:

• Gold terminations: (P termination option): active face up
• Tin / silver terminations: (F termination option): active face down in tape and reel
  active face up in waffle pack

Note

• Please refer to Vishay Sfernice Application Note “Guidelines for Vishay Sfernice Resistive and Inductive Products” for soldering recommendation (document number 52029, 3. Guidelines for Surface Mounting Components (SMD), profile number 3 applies

<table>
<thead>
<tr>
<th>SIZE</th>
<th>MOQ</th>
<th>NUMBER OF PIECES PER PACKAGE</th>
<th>TAPE WIDTH</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td>WAFLE PACK 2&quot; x 2&quot;</td>
<td>TAPE AND REEL</td>
</tr>
<tr>
<td></td>
<td></td>
<td>TAPE AND REEL</td>
<td>MIN.</td>
</tr>
<tr>
<td>02016</td>
<td>See MOQ mentioned</td>
<td>484</td>
<td>100</td>
</tr>
<tr>
<td></td>
<td>on preferred models and values</td>
<td></td>
<td>8 mm</td>
</tr>
<tr>
<td>0402</td>
<td>100</td>
<td></td>
<td></td>
</tr>
<tr>
<td>0603</td>
<td>100</td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

PACKAGING RULES

Waffle Pack

Can be filled up to maximum quantity indicated in the table here above, taking into account the minimum order quantity. When quantity ordered exceeds maximum quantity of a single waffle pack, the waffle packs are stacked up on the top of each other and closed by one single cover. To get “not stacked up” waffle pack in case of ordered quantity > maximum number of pieces per package: Please consult Vishay Sfernice for specific ordering code.

Tape and Reel

See Part Numbering information to get the quantity desired by tape.

In regard to the CH02016 size only, up to 5 empty cavities can be found every 1000 parts in the reel. Nevertheless, the number of requested parts will be respected.
### GLOBAL PART NUMBER INFORMATION

New Global Part Numbering: CH0402-50RJF (preferred part number format)

<table>
<thead>
<tr>
<th>C</th>
<th>H</th>
<th>0</th>
<th>4</th>
<th>0</th>
<th>2</th>
<th>-</th>
<th>5</th>
<th>0</th>
<th>R</th>
<th>J</th>
<th>F</th>
<th>T</th>
<th>9</th>
<th>9</th>
<th>9</th>
</tr>
</thead>
<tbody>
<tr>
<td>CH</td>
<td>02016</td>
<td>0402</td>
<td>0603</td>
<td>10R to 500R</td>
<td>F (flip chip): SnAg over nickel barrier</td>
<td>G = 2 %</td>
<td>J = 5 %</td>
<td>For more information see Codification of Packaging table</td>
<td>From 1 to 3 digits. Leave blank if no option.</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

Historical Part Number example: CH02016-100RGFT1K (tapes of 1K pieces)
CH0402-50RJF (waffle pack)

CHKIT Part Numbers (3):
CHKIT-02016
CHKIT-0402

Notes:
- Historical part numbers are not recommended but can still be used for ordering
- Gold termination for application in hermetic package. Can also be mounted on PCB with SnAg solder paste
- CHKIT for 0603 size is not available

### CODIFICATION OF PACKAGING

**WAFFLE PACK** (available for all sizes)

- **W**
  - 100 min., 1 mult.

**PLASTIC TAPE** (standard packaging for all sizes)

- **T**
  - 100 min., 1 mult.
- **TA**
  - 100 min., 100 mult.
- **TB**
  - 250 min., 250 mult.
- **TC**
  - 500 min., 500 mult.
- **TD**
  - 1000 min., 1000 mult.
- **TE**
  - 2500 min., 2500 mult.
- **TF**
  - Full tape (quantity depending on size of chips)

**PAPER TAPE** (available for 0402 and 0603)

- **PT**
  - 100 min., 1 mult.
- **PA**
  - 100 min., 100 mult.
- **PB**
  - 250 min., 250 mult.
- **PC**
  - 500 min., 500 mult.
- **PD** (not available for size 0402)
  - 1000 min., 1000 mult.
- **PE** (not available for size 0402)
  - 2500 min., 2500 mult.
- **PF** (not available for size 0402)
  - Full tape (quantity depending on size of chips)

### TYPICAL HIGH FREQUENCY PERFORMANCE ELECTRICAL MODEL

![Typical High Frequency Performance Electrical Model](image)

- **C** Internal shunt capacitance
- **L** Internal inductance
- **R** Resistance
- **Z** Internal impedance (R, L, C)
- **Lc** External connection inductance
- **Cg** External capacitance to ground
The complex impedance of the chip resistor is given by the following equations:

\[ Z = \frac{R + j\omega(L - R^2C - L^2C\omega^2)}{1 + C((R^2C - 2L)\omega^2 + L^2C\omega^4)} \]

\[ \frac{[Z]}{R} = \frac{1}{1 + C((R^2C - 2L)\omega^2 + L^2C\omega^4)} \times \sqrt{1 + \left(\frac{\omega(L - R^2C - L^2C\omega^2)}{R}\right)^2} \]

**Notes**

- \( \omega = 2 \times \pi \times f \)
- \( f \): frequency

R, L and C are relevant to the chip resistor itself.
Lc and Cg also depend on the way the chip resistor is mounted.
It is important to notice that after assembly the external reactance of Lc and Cg will be combined to internal reactance of L and C. This combination can upgrade or downgrade the HF behavior of the component.
This is why we are displaying three sets of data:

- \( \frac{[Z]}{R} \) versus frequency curves which aim to show at a glance the intrinsic HF performance of a given chip resistor
- \( \frac{[Z_{\text{total}}]}{R} \) versus frequency curves which aim to show the behavior of the chip resistor when mounted

These lines are terminated with adapted source and load impedance respectively \( Z_s \) and \( Z_l \) with \( Z_0 = Z_L = Z_s \) (for others configurations please consult us).

Equivalent circuit for S-parameters:

S-parameters are computed taking into account all the resistive, inductive and capacitive elements (Z total) and \( Z_0 = Z_L = Z_s = R \).

For simulation purposes, those S-parameter data are available for download here: [www.vishay.com/doc?753061](http://www.vishay.com/doc?753061)
INTERNAL IMPEDANCE CURVES

Internal impedance curve for 02016 size (F and P terminations)

Internal impedance curve for 0402 size (F and P terminations)
INTERNAL IMPEDANCE CURVES

Internal impedance curve for 0402 size (N and G terminations)

Internal impedance curve for 0603 size (F and P terminations)
INTERNAL IMPEDANCE CURVES

Internal impedance curve for 0603 size (N and G terminations)

INTERNAL IMPEDANCE CURVES \left(\frac{|Z_{total}|}{R}\right)

Internal impedance curve for 02016 size (F and P terminations)
INTERNAL IMPEDANCE CURVES ($|Z_{TOTAL}| / R$)

Internal impedance curve for 0402 size (F and P terminations)

Internal impedance curve for 0402 size (N and G terminations)
INTERNAL IMPEDANCE CURVES (\(|Z_{\text{TOTAL}}| / R\))

Internal impedance curve for 0603 size (F and P terminations)

Internal impedance curve for 0603 size (N and G terminations)
S-PARAMETER

CH02016 (F and P Terminations)

CH02016 flip chip ($Z_0 = Z_I = Z_s = R = 50\, \Omega$)

CH0402 flip chip ($Z_0 = Z_I = Z_s = R = 50\, \Omega$)

CH0402 wraparound ($Z_0 = Z_I = Z_s = R = 50\, \Omega$)

CH0402 (F and P Terminations)

CH0402 flip chip ($Z_0 = Z_I = Z_s = R = 100\, \Omega$)

CH0402 wraparound ($Z_0 = Z_I = Z_s = R = 100\, \Omega$)

CH0402 (N and G Terminations)

CH0402 wraparound ($Z_0 = Z_I = Z_s = R = 50\, \Omega$)

CH0402 wraparound ($Z_0 = Z_I = Z_s = R = 100\, \Omega$)
S-PARAMETER

CH0603 (F and P Terminations)

CH0603 flip chip ($Z_0 = Z_i = Z_s = R = 50 \, \Omega$)

CH0603 flip chip ($Z_0 = Z_i = Z_s = R = 100 \, \Omega$)

CH0603 (N and G Terminations)

CH0603 wraparound ($Z_0 = Z_i = Z_s = R = 50 \, \Omega$)

CH0603 wraparound ($Z_0 = Z_i = Z_s = R = 100 \, \Omega$)
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